

In the Specification

Amend the paragraph beginning on page 4, line 26 and ending on page 5, line 8 as follows:

The apparatus utilized to carry out the foregoing method comprises an assembly that includes an emitter housing in which the laser emission source is located. A marking head is pivotally affixed directly to the emitter housing and electronically and optically communicates therewith. Beam directing apparatus in the marking head is electronically connected to a controller to receive and process the signals for controlling the beam directing apparatus to move the laser beam over the surface to etch the desired pattern. Preferably, the marking head is provided with one or more suction devices for securing the marking head in proper alignment and spacing with the surface being etched and interlocks are provided to prevent the firing of the laser until the marking head is correctly positioned with respect to the surface to be etched.

Amend the second full paragraph on page 5 beginning at line 11 as follows:

While the emitter housing and marking head of the emitter/marking head assembly are separate units, the marking head is immediately adjacent to the laser source to shorten the optical path for the laser beam. The marking head is pivotally carried by the emitter housing for pivoting movement in relation to the emitter housing. The marking head may be mounted on either sidewall or the top or bottom wall of the emitter housing.